Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.036mm	
5		Dielectric 1	Polyamide	0.127mm	4.2
6		L2	Copper	0.036mm	
7		Dielectric 2	Polyamide	0.127mm	4.2
8		L3	Copper	0.036mm	
9		Dielectric 3	FR4	1.200mm	4.2
10		L4	Copper	0.036mm	
11		Dielectric3	FR-4	0.320mm	4.8
12		L5	Copper	0.036mm	
13		Dielectric2	FR-4	0.320mm	4.8
14		Bottom Layer	Copper	0.036mm	
15		Bottom Solder	Solder Resist	0.010mm	3.5
16		Bottom Overlay			
17		Bottom Paste			
	Height : 2.329mm				